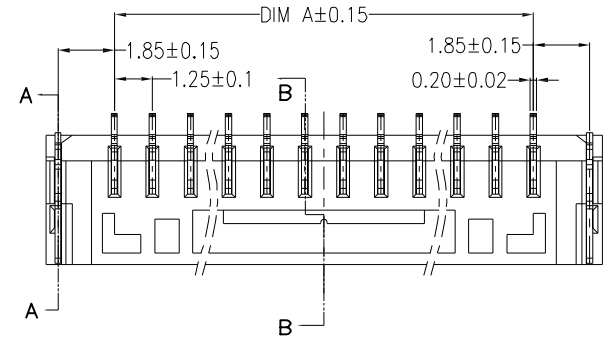
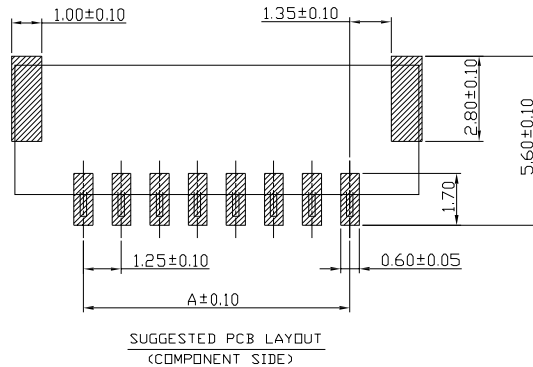
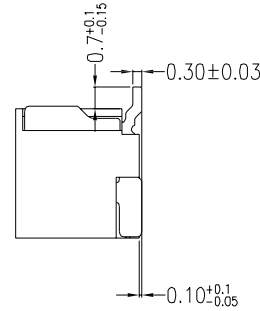
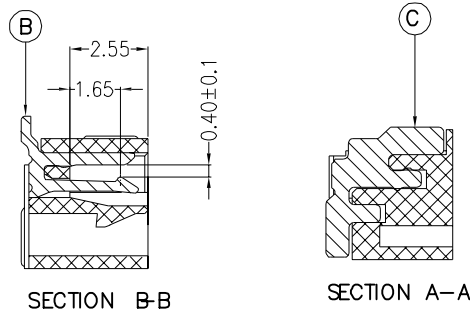


孔位 \ 尺寸	DIM A	DIM B	DIM C	孔位 \ 尺寸	DIM A	DIM B	DIM C
2P	1.25	5.75	3.95	9P	10.00	14.50	12.70
3P	2.50	7.00	5.20	10P	11.25	15.75	13.95
4P	3.75	8.25	6.45	11P	12.50	17.00	15.20
5P	5.00	9.50	7.70	12P	13.75	18.25	16.45
6P	6.25	10.75	8.95	13P	15.00	19.50	17.70
7P	7.50	12.00	10.20	14P	16.25	20.75	18.95
8P	8.75	13.25	11.45	15P	17.50	22.00	20.20



主要技术参数 Main Specifications

线 数 (Poles): 02 to 15
接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
绝缘电阻 (Insulation resistance): $\geq 100\text{M}\Omega$
额定电压 (Rated voltage): 50V AC DC
额定电流 (Rated current): 1.0A AC DC
耐 电 压 (Withstand Voltage): 500V AC/minute
温度范围 (Temperature Range): $-40^{\circ}\text{C} \sim +110^{\circ}\text{C}$

NO.	DESCRIPTION	QTY	MATERIAL	PLATING/COLOR
A	Insulator	1	LCP (UL94V-0)	Beige
B	Contacts	2~15	PhosphorBronze	Tin-plated
C	Solder Tab	2	PhosphorBronze	Tin-plated

UNITS mm		mstconn		深圳市德瑞电子有限公司			
MAT'L				SHENZHEN DERUI ELECTRONIC CO., LTD.			
FINISH		PART NO.(INTENDED USE) GH1. 25-nAB		TITLE: GH1. 25立贴插座			
		APPD:		DWG NO.: GH1. 25-nAB			
Q'TY		CHKD:					
PCS		DR: HU 2016.09.28					
		17		18		19	